



Material Content Data Sheet				RoHS		Halogen-Free		
Sales Product Name	TLE6251D			Issued		19. July 2018		
MA#	MA001028510							
Package	PG-DSO-8-16			Weight*		83.37 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.799	3.36	3.36	33576	33576
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		108	
	non noble metal	zinc	7440-66-6	0.036	0.04		430	
	non noble metal	iron	7439-89-6	0.717	0.86		8602	
	non noble metal	copper	7440-50-8	29.121	34.93	35.84	349295	358435
wire	noble metal	gold	7440-57-5	0.133	0.16	0.16	1595	1595
encapsulation	organic material	carbon black	1333-86-4	0.095	0.11		1144	
	plastics	epoxy resin	-	4.389	5.26		52645	
	inorganic material	silicondioxide	60676-86-0	43.223	51.85	57.22	518443	572232
leadfinish	non noble metal	tin	7440-31-5	0.814	0.98	0.98	9762	9762
plating	noble metal	silver	7440-22-4	0.650	0.78	0.78	7799	7799
glue	plastics	acrylic resin	-	0.305	0.37		3652	
	noble metal	silver	7440-22-4	1.080	1.29	1.66	12949	16601
*deviation	< 10%			S	um in total:	100.00		1000000

Important Remarks:

- 1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- 2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- 3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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